



THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **KAMIGAWA, Hidenori, et al.**

Group Art Unit: **2836**

Serial No.: **10/721,867**

Examiner: Not Yet Assigned

Filed: **November 26, 2003**

P.T.O. Confirmation No.: 6089

For. **SOLID ELECTROLYTIC CAPACITORS**

SUBMISSION OF SUBSTITUTE DECLARATION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

April 14, 2004

Sir:

Submitted herewith for filing is a Substitute Declaration for the above-identified application. This Substitute Declaration is being submitted in order to correct the previously submitted missing second prior foreign application number 2002-378501 - Japan - 26-Dec-2002.

Also attached is a copy of the original declaration with the corrections highlighted.

In the event any fees are due in connection with this paper, please charge our Deposit Account No. 01-2340.

Respectfully submitted,

ARMSTRONG, KRATZ, QUINTOS,
HANSON & BROOKS, LLP

Donald W. Hanson
Attorney for Applicants
Reg. No. 27,133

DWH/rmp
Atty. Docket No. **031289**
1725 K Street, N.W. Suite 1000
Washington, D.C. 20006
(202) 659-2930



23850

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Enclosures: (1) Substitute Declaration
(2) Copy of Original Declaration filed November 26, 2003

NOTES

- A. Please list all foreign applications relating to the invention and check "yes" or "no."
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate city and state, for residence outside the U.S., indicate city and country. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C) Full name of sole or first inventor (given name, family name) _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

Full name of second inventor (given name, family name) _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

Full name of third inventor (given name, family name) _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

Full name of fourth inventor (given name, family name) Hiroyuki KOYAMA

Inventor's Signature Hiroyuki Koyama Date February 12, 2004

Residence Narita-shi, Chiba, Japan Citizenship Japanese

Post Office Address 920-505, Hanazakicho, Narita-shi, Chiba 286-0033, Japan

Full name of fifth inventor (given name, family name) _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

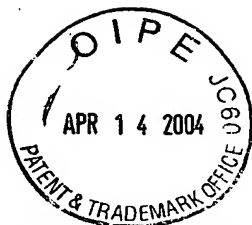
Post Office Address _____

Full name of sixth inventor (given name, family name) _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____



Docket No. _____

Armstrong, Kratz, Quintos, Hanson & Brooks, LLP

DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

SOLID ELECTROLYTIC CAPACITORS

the specification of which is attached hereto unless the following is checked

☐ was filed on _____ as United States Application Number or PCT International Application Number _____ and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed.

				Priority Claimed
(List prior foreign applications. See note A)	2002-350698 (Number)	Japan (Country)	3-Dec-2002 (Day/Month/Year Filed)	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
	2002-378501 (Number)	Japan (Country)	26-Dec-2002 (Day/Month/Year Filed)	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
	_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No
	_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No

(See note B) ☐ See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

			Status
(List prior U.S. Applications)	_____ (Application Serial No.)	_____ (Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
	_____ (Application Serial No.)	_____ (Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
	_____ (Application Serial No.)	_____ (Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
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(See note C) Full name of sole or first inventor (given name, family name) Hidenori KAMIGAWA

Inventor's Signature Hidenori Kamigawa Date November 13, 2003
Residence Higashiosaka-shi, Osaka, Japan Citizenship Japanese
Post Office Address 1482-501, Hishie, Higashiosaka-shi, Osaka 578-0984, Japan

Full name of second inventor (given name, family name) Kouichi MORITA

Inventor's Signature Kouichi Morita Date November 13, 2003
Residence Hirakata-shi, Osaka, Japan Citizenship Japanese
Post Office Address 1-2-16-1001, Deguchi, Hirakata-shi, Osaka 573-0065, Japan

Full name of third inventor (given name, family name) Hitoshi IBUTA

Inventor's Signature H. Ibuta Date November 13, 2003
Residence Hirakata-shi, Osaka, Japan Citizenship Japanese
Post Office Address 1-12-61, Souya, Hirakata-shi, Osaka 573-0113, Japan

Full name of fourth inventor (given name, family name)

Inventor's Signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of fifth inventor (given name, family name)

Inventor's Signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of sixth inventor (given name, family name)

Inventor's Signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

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the specification of which is attached hereto unless the following is checked

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	(Number)	(Country)	(Day/Month/Year Filed)	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
(List prior foreign applications. See note A)				<input type="checkbox"/> Yes <input type="checkbox"/> No
	(Number)	(Country)	(Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No
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(List prior U.S. Applications)			<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
	(Application Serial No.)	(Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
	(Application Serial No.)	(Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
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(See note C) Full name of sole or first inventor (given name, family name) Hiroyuki KOYAMA

Inventor's Signature Hiroyuki Koyama Date November 13, 2003
Residence Narita-shi, Chiba, Japan Citizenship Japanese
Post Office Address 920-505, Hanazakicho, Narita-shi, Chiba 286-0033, Japan

Full name of second inventor (given name, family name)

Inventor's Signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of third inventor (given name, family name)

Inventor's Signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of fourth inventor (given name, family name)

Inventor's Signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of fifth inventor (given name, family name)

Inventor's Signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of sixth inventor (given name, family name)

Inventor's Signature _____ Date _____
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